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SDURB1040CT ULTRAFAST PLASTIC RECTIFIER

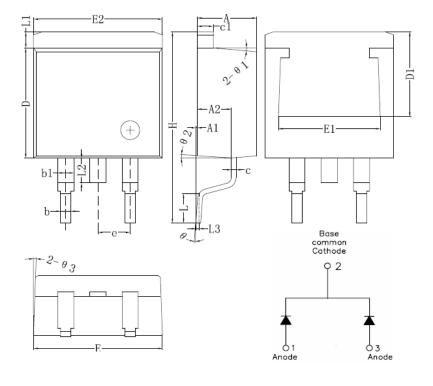
Applications:

- Antiparallel diode for high frequency switching devices
- Anti saturation diode
- Snubber diode
- · Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- Inductive heating and melting
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders

Features:

- Ultra-Fast Switching
- High Current Capability
- Low Reverse Leakage Current
- High Surge Current Capability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- · Additional testing can be offered upon request

Mechanical Dimensions: In mm



Symbol	Dimensions in millimeters			
	Min.	Typical	Max.	
Α	4.55	4.70	4.85	
A1	0	0.10	0.25	
A2	2.59	2.69	2.89	
b	0.71	0.81	0.96	
b1		1.27		
С	0.36	0.38	0.61	
c1	1.17	1.27	1.37	
D	8.55	8.70	8.85	
D1	6.40			
E	10.01	10.16	10.31	
E1	7.6			
E2	9.98	10.08	10.18	
е		2.54		
Н	14.6	15.1	15.6	
L	2.00	2.30	2.70	
L1	1.17	1.27	1.40	
L2			2.20	
L3		0.25BSC		
е	0	-	8°	
e1		5°		
e2		4°		
e3		4°		

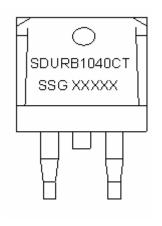
D² PAK

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Marking Diagram:



Where XXXXX is YYWWL

SDUR = Device Type B = Package type

10 = Forward Current (10A) 40 = Reverse Voltage (400V)

CT = Configuration

 SSG
 = SSG

 YY
 = Year

 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

Ordering Information:

Device	Package	Shipping
SDURB1040CT	D ² PAK	900pag/ rool
	(Pb-Free)	800pcs/ reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} V_{RRM} \ V_{RWM} \ V_{R} \end{array}$	-	400	V
Average Forward Current	lo _(AV)	50% duty cycle T _C =112℃, rectangular wave form	10	Α
Peak One Cycle Non-Repetitive Surge Current (per leg)	I _{FSM}	8.3ms, Half Sine pulse	80	А

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Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Forward Voltage Drop (per leg) *	V _F	@ I_F = 5A, Pulse, T_J = 25°C	1.3	V
Reverse Current(per leg) *	I _R	@V _R = rated V _R T _J = 25℃	30	μA
Reverse Recovery Time	t _{rr}	I_F =500mA, I_R =1A,and I_{rm} =250mA	45	ns

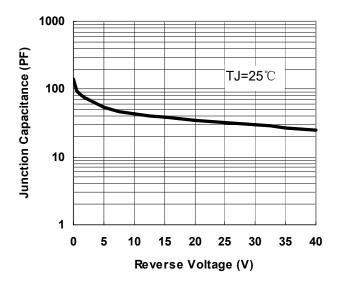
^{*} Pulse width < 300 μ s, duty cycle < 2%

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	$^{\circ}$
Storage Temperature	T _{stg}	-	-55 to +150	$^{\circ}$
Typical Thermal Resistance Junction to Case	$R_{ heta JC}$	DC operation	3.5	°C /W
Approximate Weight	wt	-	1.85	g
Case Style		D2PAK	_	



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100 10 TJ=125℃ 1 0.1 0.01 TJ=25℃ 0.001 20 100 10 30 40 50 60 70 80 90 Percent of Rated Peak Reverse Voltage (%)

Fig.1-Typical Junction Capacitance

Fig.2-Typical Reverse Characteristics

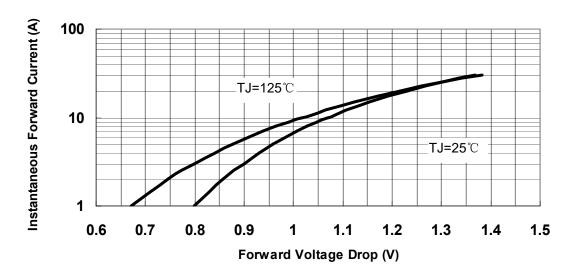


Fig.3-Typical Instantaneous Forward Voltage Characteristics

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